



File No.: R 50471143





FEATURES

- · With arc extinguishing magnets
- · High performance DC relay for photovoltaic power generation systems, energy storage system and xEV charging device, etc

CONTACT RATINGS

Contact Arrangement	1A
Contact Resistance	Max.10mΩ (by voltage drop 6VDC 20A)
Contact Material	Silver Alloy(Non-Cd)
Contact Rating(Resistive)	15A 500VDC, On 1s/Off 19s, 30,000 ops.
Max. Switching Voltage	500VDC
Max. Switching Current	15A
Mechanical Life	1×10 ⁶ operations
Electrical Life	15A 500VDC, ON 1s/OFF 19s 30,000 ops 20A 300VDC, ON 1s/OFF 19s 30,000 ops

CHARACTERISTICS

Insulation Re	esistance	1000MΩ (at 500VDC)	
Dielectric	Between coil & contacts	5000VAC 1min	
Strength	Between open contacts	2000VAC 1min	
Surge Voltage		10kV(1.2/50μS)	
Operate time	e (at nomi. volt.)	≤30ms	
Release time (at nomi. volt.)		≤10ms	
Humidity		5%~85% RH	
Operating C	ondition	-40°C~+85°C	
Shock	Functional	98m/s²	
Resistance	Destructive	980m/s ²	
Vibration res	sistance	10Hz ~ 55Hz 1.5mm DA	
Unit weight		Approx. 130g	
Construction		Sealed Type, Dust Cover Type, Flux Tight Type	

Notes: The data shown above are initial values.

ORDERING INFORMATION

HAG01M F A S DC 12 Model -F:Class F H:Class H -A:SPDM single-pole, double-make C:Dust Cover Type S:Sealed Type -E:Flux Tight Type Coil:DC -Coil Voltage

- 1. PC board assembled with dust cover type and flux tight type relays can not be washed and/or coated.
- 2. Dust cover type and flux tight type relays can not be used in the environment with dust, or H₂S, SO₂, NO₂ or similar gaseous environment etc.

COIL DATA at 25°C

Nominal Voltage VDC	Operate Voltage (Max.) VDC	Release Voltage (Min.) VDC	*Max. Allowable Voltage VDC	Coil Resistance Ω±10%
6	4.50	0.30	6.60	14.4
9	6.75	0.45	9.90	32.4
12	9.00	0.60	13.20	57.6
24	18.00	1.20	26.40	230.4

Note:"*Max Allowable Voltage": The relay coil can endure max allowable voltage for a short period time only.

COIL

Coil Power Approx. 2.5W

This datasheet is for customers' reference. All the specifications are subject to change without notice.



SAFETY APPROVAL RATINGS

UL&CUL	20A 300VDC, ON 0.5s/OFF 9s, 25°C, 3×10 ⁴ OPS
	20A 300VDC, ON 0.5s/OFF 9s, 85°C, 1×10 ⁴ OPS

NOTES

- 1. All values without specified temperature are at 25°C.
- 2. The above lists the typical loads only. Other loads may be available upon request.

TüV 10A 500VDC, ON 1s/OFF 9s, 25°C, 3×10⁴ OPS 15A 500VDC, ON 1s/OFF 19s, 25°C, 3×10⁴ OPS 20A 300VDC, ON 1s/OFF 19s, 25°C, 3×10⁴ OPS 10A 500VDC, ON 1s/OFF 9s, 85°C, 1×10⁴ OPS 15A 500VDC, ON 1s/OFF 19s, 85°C, 1×10⁴ OPS 20A 300VDC, ON 1s/OFF 19s, 85°C, 1×10⁴ OPS

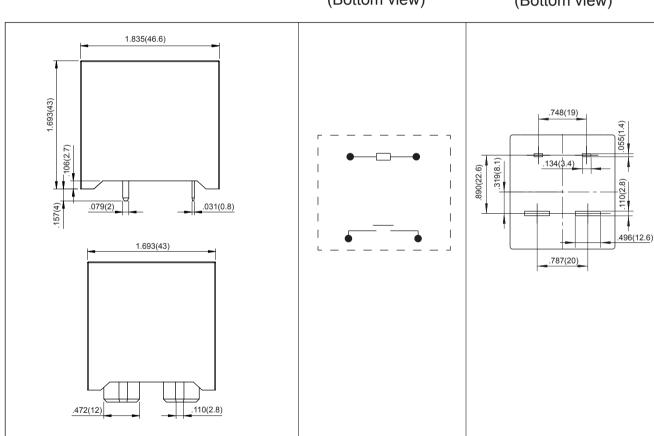
OUTLINE DIMENSIONS, WIRING DIAGRAM AND PC BOARD LAYOUT.

Unit: inch(mm)

Outline Dimensions

Wiring Diagram (Bottom view)

PCB Layout (Bottom view)



Remark:1) In case of no tolerance shown in outline dimension: outline dimension ≤1mm,tolerance should be ±0.2mm; outline dimension >1mm and ≤5mm,tolerance should be ±0.3mm;outline dimension >5mm, tolerance should be ±0.4mm.

2) The tolerance without indicating for PCB layout is always ±0.1mm.

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PACKAGING SPECIFICATION

BLISTER BOX	OUTER CARTON	OUTER CARTON SIZE
9PCS	54PCS	L455mm*W220mm*H185mm

APPLICATION GUIDELINES

Automatic Wave Soldering

- * Wave solder is the optimum method for soldering.
- * Adjust the level of solder so that it does not overflow onto the top of the PC board.
- * Unless otherwise specified, solder under the following conditions depending on the type of relay.

Preheat time	Rising slope	Decreasing slope	Slodering temperature
20°C-100°C	20°C-120°C	Peak-150°C	255°C-265°C
90±5 seconds	<3°C/s	<4°C/s	3~5s

Hand Soldering

* Keep the tip of the soldering iron clean.

Solder Iron	30W or 60W
Iron Tip Temperature	Approx. 350°C 662°F
Solder Time	Within approx. 3 seconds

- * Immediate air cooling is recommended to prevent deterioration of the relay and surrounding parts due to soldering heat.
- * Although the sealed type relay can be cleaned, avoid immersing the relay into cold liquid (such as washing solvent) immediately after soldering. Doing so may deteriorate the sealing performance.

Discard the dropped product

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